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12002 U.S. PRO

**U.S. UTILITY Patent Application**

**PATENT NUMBER and  
ISSUE DATE**

APPL NUM 10053278	FILING DATE 01/16/2002	CLASS 228	SUBCLASS 180.22	GAU 1725	EXAMINER Stoner
**APPLICANTS: Byun Hyung-Jik; Lee Kyu-Jin;					
**CONTINUING DATA VERIFIED: none KS					
<b>BEST AVAILABLE COPY</b>					
** FOREIGN APPLICATIONS VERIFIED: REPUBLIC OF KOREA 2001-5383 02/05/2001 OK KS					
PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiner's initials		<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <i>[Handwritten signature]</i>	ATTORNEY DOCKET NO 9903-40		
TITLE : Semiconductor chip package comprising enhanced pads					
U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)					

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>Assistant Examiner</b>		<b>CLAIMS ALLOWED</b>	
				<b>Total Claims:</b>	
<b>ISSUE FEE</b>				<b>DRAWING</b>	
<b>Amount Due</b>	<b>Date Paid</b>			<b>Sheets Draw.</b>	<b>Figs.Draw.</b>
<input type="checkbox"/> <b>TERMINAL</b> <b>DISCLAIMER</b>		<b>Primary Examiner</b>		<b>Application Examiner</b>	
		<b>PREPARED FOR ISSUE</b>			
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